

## Stellaris® LM3S9B92 RevB1 Errata

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Date	Revision	Description

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Erratum Number	Erratum Title	Revision(s) Affected

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1	JTAG	
1.1	JTAG INTEST instruction does not work	
	Description:	
	Workaround:	
	Silicon Revision Affected:	
	Fixed:	
1.2	The Recover Locked Device sequence does not worl	k as expected
	Description:	•
	Workaround:	
	1.	

	2.						
	3.						
	4.						
	Silicon Re	vision Affe	cted:				
	Fixed:						
2	Syste	m Con	itrol				
2.1			o-Sleep mod Flash memo		able at highe	er speeds w	hen
	Description	on:					
	Workarou	nd:					
	1.						
	2.						
	Silicon Re	vision Affe	cted:				
	Fixed:						
2.2	Device signals	_	ities registe	rs may r	not accurately	y reflect ava	ailable
	Descriptio	on:					
	DC3	DC4	DC5		DC8		

	Workaround:
	Silicon Revision Affected:
	Fixed:
2.3	The PIOSC is not trimmed by the factory  Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
3	Internal Memory
3 3.1	Internal Memory Cumulative page erases may introduce bit errors in Flash memory Description:
	Cumulative page erases may introduce bit errors in Flash memory
	Cumulative page erases may introduce bit errors in Flash memory
	Cumulative page erases may introduce bit errors in Flash memory  Description:
	Cumulative page erases may introduce bit errors in Flash memory  Description:  Workaround:
	Cumulative page erases may introduce bit errors in Flash memory Description:  Workaround:  1.

	Fixed:
3.2	Flash Write Buffer does not function above 50 MHz  Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
4	ROM
4.1	Ethernet fails to connect when using the Boot Loader software in ROM
	Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
4.2	Some ROM functions are unsupported  Description:

	Workaround:
	Silicon Revision Affected:
	Fixed:
4.3	ROM mapping check for the Boot loader does not function properly Description:
	Workaround:

	Silicon Revision Affected:
	Fixed:
4.4	ROM_I2CMasterErr function is incorrect  Description:  I2CMCS
	Workaround:
	Silicon Revision Affected:
	Fixed:
4.5	ROM_SSIConfigSetExpClk function is incorrect  Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
4.6	ROM_USBFIFOFlush function is incorrect  Description:
	Workaround:

	Silicon Revision Affected:
	Fixed:
4.7	The option to force the ROM boot loader to execute at reset with an external pin does not function
	Description:
	PORT PIN Boot Configuration (BOOTCFG) Workaround:
	Silicon Revision Affected:
	Fixed:
5	μDMA
5.1	The µDMA controller fails to generate capture mode DMA requests from Timer A in the Timer modules
	Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
6	GPIO
6.1	Port B [1:0] pins require external pull-up resistors  Description:

	Workaround:		
	Silicon Revision Affected:		
	Fixed:		
6.2	Schmitt input featur  Description:	e does not function c	orrectly
	Workaround:		
	Silicon Revision Affected:		
	Fixed:		
7	EPI		
7.1	EPI dual-chip select	function does not wo	ork
	Description:		
	CSCFG	CSCFG EPI Host-Bus 8 Configuration	2 (EPIHB8CFG2) CSCFG
	CSCFG		Coord
	Workaround:		

Fixed:

#### 7.2 EPI Host-Bus 16 mode does not work

**Description:** 

MODE

**EPI Configuration (EPICFG)** 

Workaround:

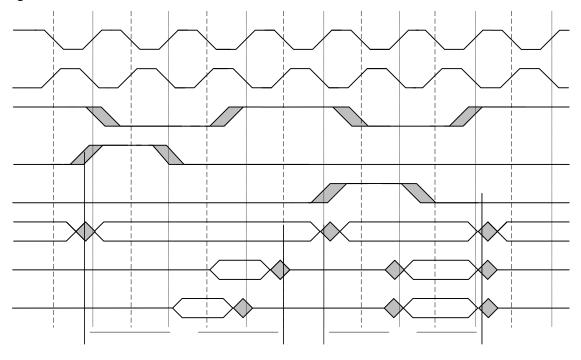
Silicon Revision Affected:

Fixed:

### 7.3 Clock signal in EPI General-Purpose mode is inverted

**Description:** 

Figure 1. Timing Differences Between Rev B and Rev C Devices



	Workaround:
	Silicon Revision Affected:
	Fixed:
8	General-Purpose Timer
8.1	The General-Purpose Timer match register does not function correctly in 32-bit mode
	Description:  GPTM Timer A Match (GPTMTAMATCHR)
	Workaround:
	Silicon Revision Affected:
	Fixed:
8.2	A spurious DMA request is generated when the timer rolls over in Input-Edge Time mode
	Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:

8.3	A spurious DMA request is generated when the timer rolls over the 16-bit boundary				
	Description:				
	Workaround:				
	Silicon Revision Affected:				
	Fixed:				
8.4	The value of the prescaler register is not readable in Edge-Count mode				
	Description:				
	GPTM Timer n (GPTMTnR)  GPTM Timer n Prescale (GPTMTnPR)				
	Workaround:				
	Silicon Revision Affected:				
	Fixed:				
8.5	ADC trigger and Wait-on-Trigger may assert when the timer is disabled				
	Description:				
	GPTM Timer n Match (GPTMTnMATCHR)  TnOTE GPTM Control (GPTMCTL)  TnEN GPTMCTL				
	GPTMTnMATCHR TnWOT GPTM Timer n Mode (GPTMTnMR)				
	Workaround:				
	TnOTE				

	Silicon Revision Affected:
	Fixed:
8.6	Wait-on-Trigger does not assert unless the TnOTE bit is set
	Description:
	Thote GPTMCTL
	Workaround:
	TNWOT GPTM Timer n Mode (GPTMTnMR)  TNOTE GPTMCTL
	TnOTE
	Silicon Revision Affected:
	Fixed:
8.7	Do not enable match and timeout interrupts in 16-bit PWM mode
	Description:
	Workaround:  GPTMTnMR GPTMIMR
	Silicon Revision Affected:
	Fixed:
8.8	Do not use µDMA with 16-bit PWM mode  Description:
	Workaround:
	Silicon Revision Affected:

	Fixed:
8.9	Writing the GPTMTnV register does not change the timer value when counting up
	Description:
	GPTM Timer n Value (GPTMTnV)
	Workaround:
	Silicon Revision Affected:
	Fixed:
8.10	The prescaler does not work correctly when counting up in periodic or one-shot mode
	Description:
	Workaround:
	Silicon Revision Affected:
	Fixed:
8.11	Snapshot must be enabled in both Timer A and B when in 32-bit snapshot mode
	Description:
	GPTM Timer A (GPTMTAR)
	Workaround:
	TASNAPS TBSNAPS GPTM Timer A Mode (GPTMTAMR) GPTMTAR
	Silicon Revision Affected:

	Fixed:				
9	Watchdog Timer 1				
9.1	.1 Writes to Watchdog Timer 1 module WDTLOAD register som fail				
	Description:				
	Load (WDTLOAD)	WRC	Watchdog WDTCTL1		
	Workaround:				
	WDTLOAD				
	Silicon Revision Affected:				
	Fixed:				
10	ADC				
10.1	ADC hardware averaging produces erroneous results in differential mode				
	Description:				
	Workaround:				
	Silicon Revision Affected:				
	Fixed:				
10.2	The ADCSPC register does not for	unction			

**Description:** 

**ADC Sample Phase Control (ADCSPC)** 

	Workaround:			
	Silicon Revision Affe	ected:		
	Fixed:			
11	UART			
11.1	UART Smart Ca	ard (ISO 7816) mode	does not function	
	Description:			
	UnTX			
	Workaround:			
	Silicon Revision Affe	ected:		
	Fixed:			
11.2	When in IrDA mode, the UnRx signal requires configuration ever if not used			
	Description:			
			UnRx	
	Workaround:			
	UnRx		UnRx UnRx	
	Silicon Revision Affe	ected:		
	Fixed:			
11.3	Phantom interr	rupts occur in Smart	Card mode	
	UARTRIS	UARTMIS		

	Workaround:			
	PEMIS			PERIS
	Silicon Revision A	Affected:		
	Fixed:			
11.4	The RTRIS bit	t in the UARTRIS	register is only	set when the interrupt
	Description:			
	RTRIS (UARTRIS) RTIM	UART Interrupt Ma	sk (IIARTIM)	UART Raw Interrupt Status
	KIII	RTRIS	ok ( <b>0</b> / 1111111)	TCI ITA
	Workaround:			
			RTIM	
		RTRIS		
	Silicon Revision A	Affected:		
	Fixed:			
12	SSI			
12.1	An interrupt is	_	when using µDN	IA with the SSI module
	Description:			
		EOT	SSICR1	
	Workaround:	101	Gien	
	Silicon Revision A	Affected:		
	Fixed:			

#### 13 **12S**

Fixed:

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13.1	Some bits in the I2SMCLKCFG register do not funct				
	Description:				
	RXI	RXI TXI TXI	RXI	I2SMCLKCFG TXI	
	Workaround:				
	Silicon Revision	Affected:			
	Fixed:				
13.2	I <sup>2</sup> S SCLK signal is inverted in certain modes  Description:				
	Workaround:				
	1.	I2S0TXSCK		I2SOTXWS	
	2.				
	Silicon Revision	Affected:			

### 14 Ethernet Controller

# 14.1 Ethernet receive packet corruption may occur when using optional auto-clock gating

Description:

ACG Run-Mode Clock Configuration

(RCC)

Workaround:

ACG RCC

Silicon Revision Affected:

Fixed:

#### 14.2 Ethernet packet loss with cables longer than 50 meters

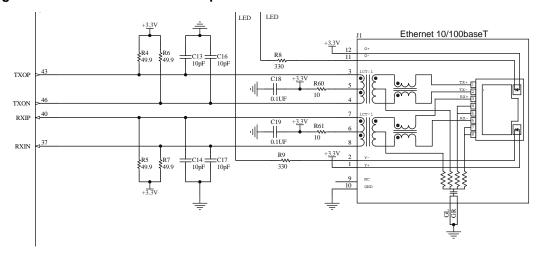
**Description:** 

Workaround:

1.

2.

Figure 2. Recommended Center-Tap Connections



	Silicon Revision Affected:				
	Fixed:				
14.3	Ethernet PHY interrupts do not function correctly  Description:				
	Workaround:				
	Silicon Revision Affected:				
	Fixed:				
14.4	Encoding error in the Ethernet MAC LED Encoding (MACLED) register  Description:				
	LED0 LED1 Ethernet MAC LED Encoding (MACLED)				
	Workaround:				
	Silicon Revision Affected:				
	Fixed:				
15	USB				
15.1	USB0ID and USB0VBUS signals are required to be connected regardless of mode				
	Description:				
	DEVMODOTG USB General-Purpose Control and Status (USBGPCS)				

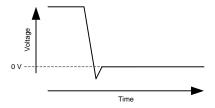
	USB0VBUS	USB0ID	USB
	General-Purpose Control and Status (USBGPCS)	DEVMOD	036
	Silicon Revision Affected:		
	Fixed:		
15.2	Latch-up may occur if power is applied to the VB VDD	US pin bu	t not to
	Description:		
	Workaround:	USI	30VBUS
	Silicon Revision Affected:		
	Fixed:		
16	PWM		
16.1	PWM generation is incorrect with extreme duty of	cycles	
	Description:		
	PW	M Load (PWM	nLOAD)

Workaround:

	PWM0 Compare A (PWM0CMPA)			
	PWM0CMPA			
	Workaround:			
	PWMnLOAD			
	Silicon Revision Affected:			
	Fixed:			
16.2	Sync of PWM does not trigger "zero" action			
	Description:			
	PWM Generator Control (PWM0GENA) ActZero			
	PWM Time Base Sync (PWMSYNC)			
	Workaround:			
	Silicon Revision Affected:			
	Fixed:			
16.3	PWM "zero" action occurs when the PWM module is disabled Description:			

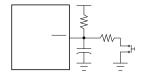
	Workaround:
	Silicon Revision Affected:
	Fixed:
16.4	PWM Enable Update register bits do not function
	Description:
	ENUPDn PWM Enable Update (PWMENUPD)
	Workaround:
	Silicon Revision Affected:
	Fixed:
17	Electrical Characteristics
17.1	Momentarily exceeding V <sub>IN</sub> ratings on any pin can cause latch-up
	Description:
	RST WAKE
	Figure 3. Incorrect Reset Circuitry
	<u> </u>

Figure 4. Excessive Undershoot Voltage on Reset



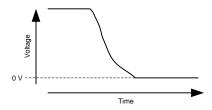
Workaround:

Figure 5. Recommended Reset Circuitry



 $\overline{\mathsf{RST}}$ 

Figure 6. Recommended Voltage on Reset



Silicon Revision Affected:

Fixed:

## 17.2 Power-on event may disrupt operation

**Description:** 

Workaround:

Figure 7. Configuration of External Regulator

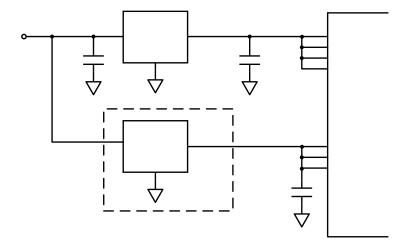
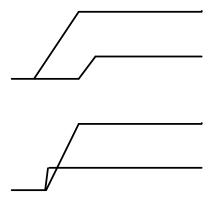


Figure 8. VDDC Sequencing Requirements



Ciliaan	Revision	A ffootod	١.
Silicon	Revision	ATTECTED	15

Fixed:

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